

Application Serial No. 10/574,308  
Reply to office action of September 18, 2008

PATENT  
Docket: CU-4715  
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**Amendments To The Abstract**

**Clean Version**

**DEC 18 2008**

Please replace the Abstract of the Disclosure with the following paragraph:

A hearing aid using a printed circuit board (PCB) is provided, which minimizes internal wires since components of the hearing aid are disposed on the PCB. In the hearing aid using a PCB, hearing aid components can be automatically disposed and soldered on the PCB, and through this the total process time, including manufacturing time, can be substantially reduced.

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**Marked-up Version**

The following marked-up version of the amended Abstract is attached hereto to aid the examiner in identifying the changes:

A hearing aid using a printed circuit board (PCB) is provided, which minimizes internal wires since components of the hearing aid are disposed on the PCB. In the hearing aid using a PCB, hearing aid components can be automatically disposed and soldered on the PCB, and through this the total process time, including manufacturing time, can be substantially reduced. ~~Since individual soldering of amplifier terminals and components of the hearing aid in an existing hearing aid faceplate manufacturing process which consumes the longest time can be automatically performed on the PCB in which the hearing aid components are automatically soldered and disposed, a total process time can be remarkably shortened.~~